

TM15G10GD

N+P-Channel Enhancement Mode Mosfet

General Description

- Low $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

Applications

- Load switch
- PWM

General Features

N Channel

$V_{DS} = 100V$ $I_D = 15A$

$R_{DS(ON)} = 105m\Omega$ (typ.) @ $V_{GS} = 10V$

P Channel

$V_{DS} = -100V$ $I_D = -15A$

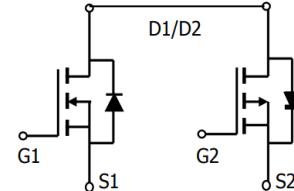
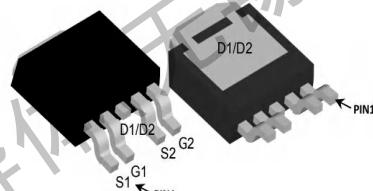
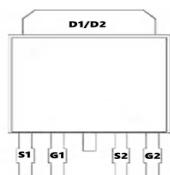
$R_{DS(ON)} = 180m\Omega$ (typ.) @ $V_{GS} = -10V$

100% UIS Tested

100% R_g Tested



GD:TO-252-4L



Marking: 15G10

Absolute Maximum Ratings ($T_c = 25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating		Units
		N-Ch	P-Ch	
V_{DS}	Drain-Source Voltage	100	-100	V
V_{GS}	Gate-Source Voltage	± 20	± 20	V
$I_D @ T_a = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^1$	15	-15	A
$I_D @ T_a = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^1$	9	-9	A
I_{DM}	Pulsed Drain Current ²	45.4	-50	A
$P_D @ T_c = 25^\circ C$	Total Power Dissipation ⁴	30	30	W
T_{STG}	Storage Temperature Range	-55 to 175	-55 to 175	°C
T_J	Operating Junction Temperature Range	-55 to 175	-55 to 175	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹	---	48	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	---	5	°C/W

TM15G10GD
N+P-Channel Enhancement Mode Mosfet

 N-CH Electrical Characteristics: ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250 \mu A$	100	---	---	V
$I_{DS(on)}$	Zero Gate Voltage Drain Current	$V_{GS}=0V, V_{DS}=100V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0A$	---	---	± 100	nA
On Characteristics³						
$V_{GS(th)}$	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250 \mu A$	1	2	3	V
$R_{DS(on)}$	Drain-Source On Resistance	$V_{GS}=10V, I_D=8A$	---	105	118	$m\Omega$
		$V_{GS}=4.5V, I_D=4A$	---	119	130	
Dynamic Characteristics⁴						
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1MHz$	---	500	---	pF
C_{oss}	Output Capacitance		---	48	---	
C_{rss}	Reverse Transfer Capacitance		---	27	---	
Switching Characteristics⁴						
$t_{d(on)}$	Turn-On Delay Time	$V_{DS}=30V, R_{GEN}=2.5 \Omega, V_{GS}=10V$	---	12.4	---	ns
t_r	Rise Time ^{2,3}		---	12	---	ns
$t_{d(off)}$	Turn-Off Delay Time ^{2,3}		---	27.3	---	ns
t_f	Fall Time ^{2,3}		---	2.6	---	ns
Q_g	Total Gate Charge ^{2,3}	$V_{GS}=10V, V_{DS}=30V, I_D=3A$	---	16.8	---	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	5	---	nC
Q_{gd}	Gate-Drain "Miller" Charge ^{2,3}		---	4	---	nC
Drain-Source Diode Characteristics						
V_{SD}	Drain Diode Forward Voltage ³	$V_{GS}=0V, I_S=1A, T_j=25^\circ C$	---	---	1.1	V
I_S	Continuous Source Current ²	$VD=VG=0V$	---	---	15	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current	$VD=VG=0V$	---	---	45.4	A

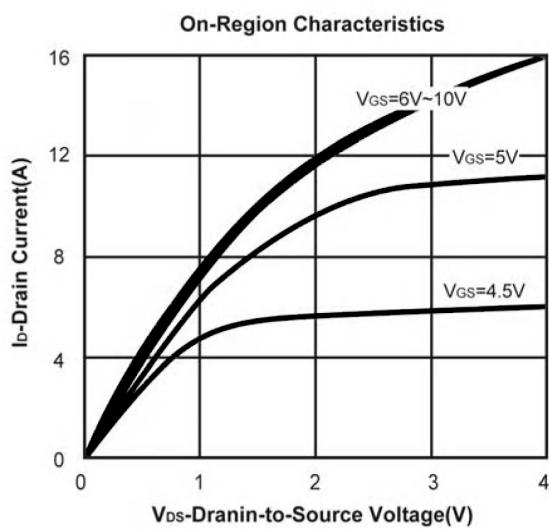
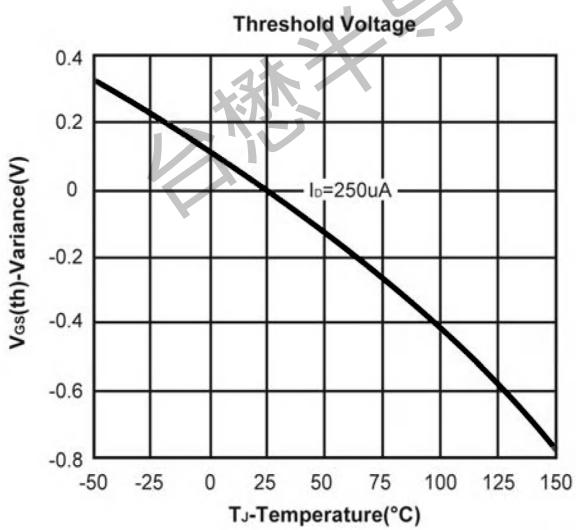
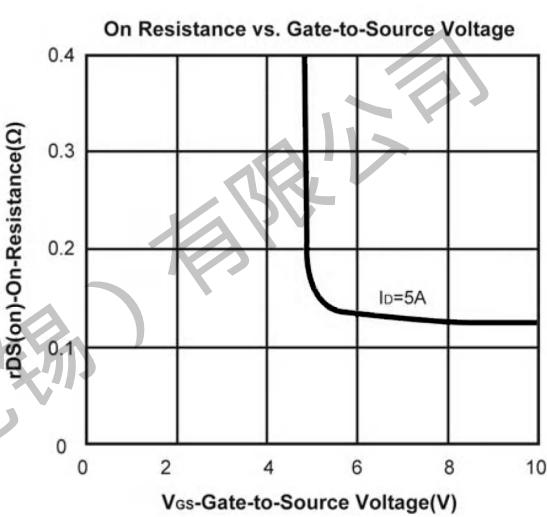
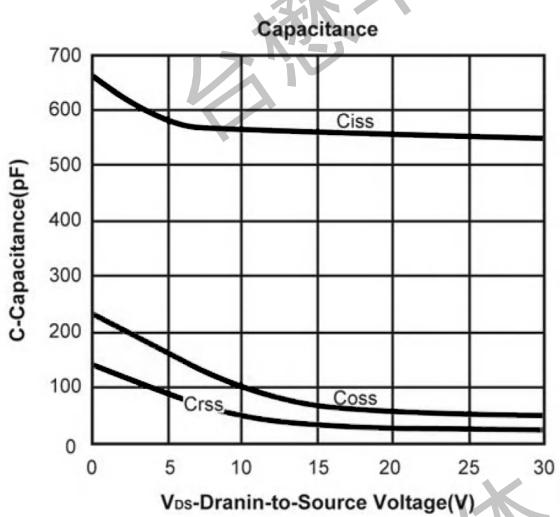
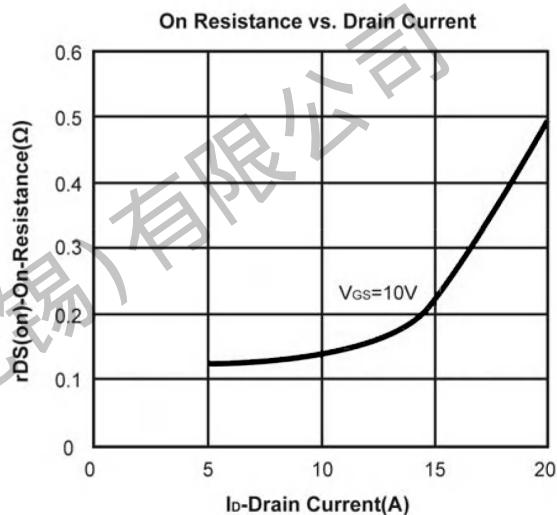
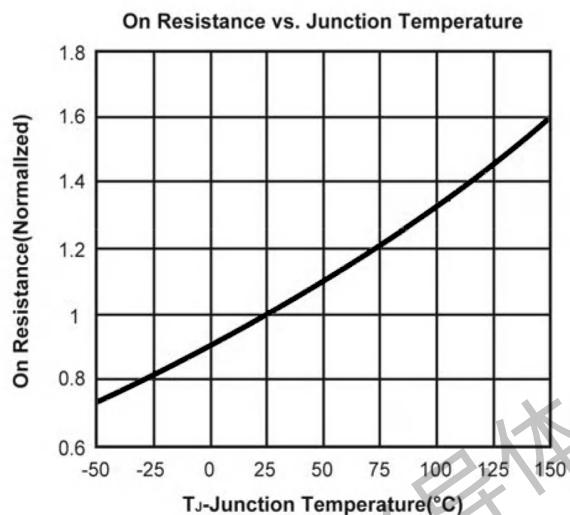
Notes:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

TM15G10GD

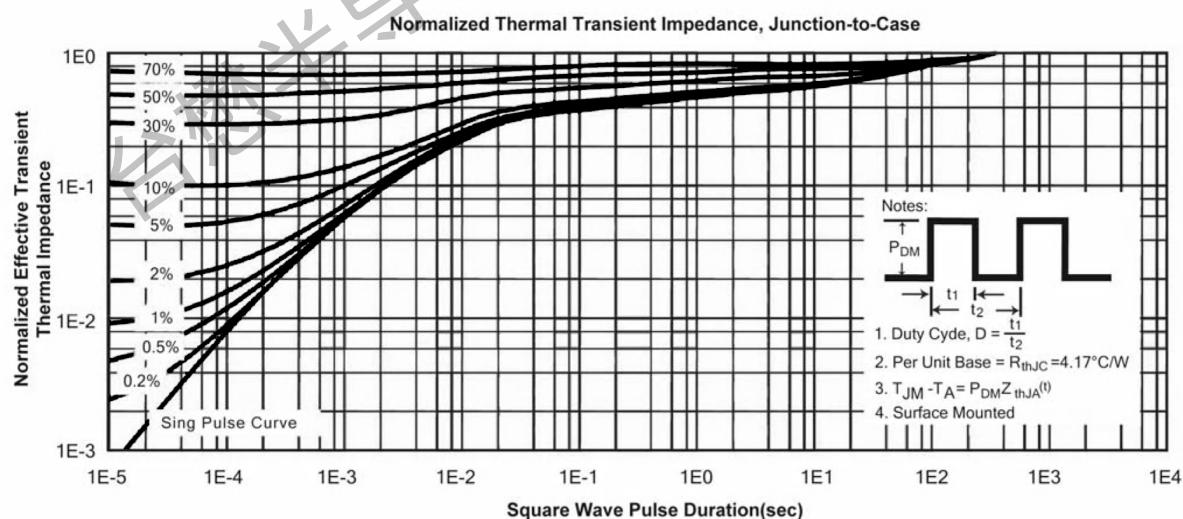
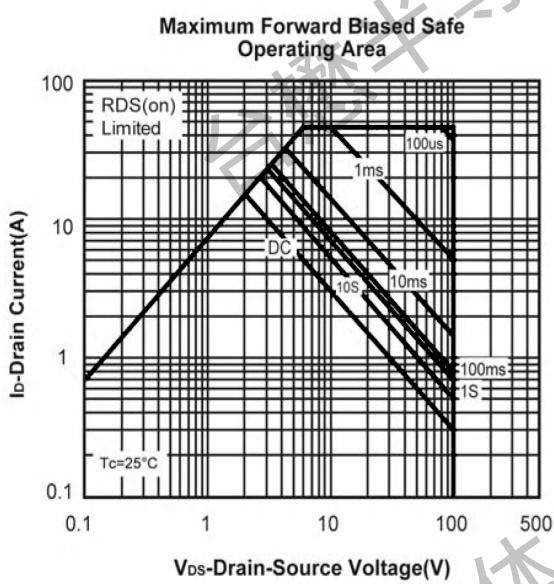
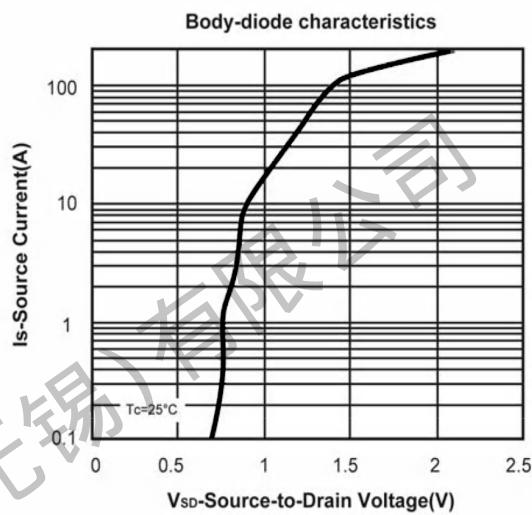
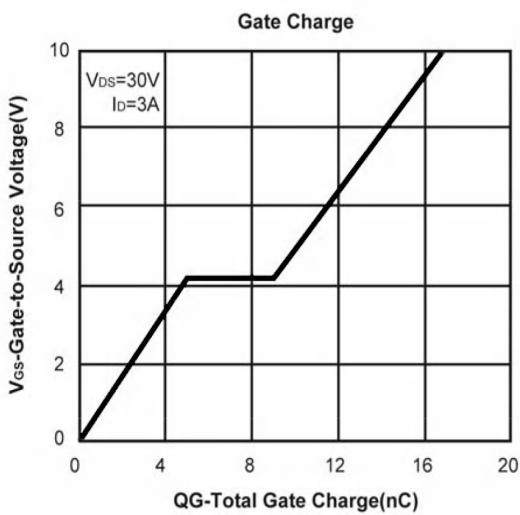
N+P-Channel Enhancement Mode Mosfet

Typical Characteristics-N



TM15G10GD

N+P-Channel Enhancement Mode Mosfet



TM15G10GD
N+P-Channel Enhancement Mode Mosfet

 P-CH Electrical Characteristics: ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250 \mu A$	-100	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS}=0V, V_{DS}=-100V$	---	---	-1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0A$	---	---	± 100	nA
On Characteristics³						
V_{GS(th)}	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250 \mu A$	-1	-2	-3	V
R_{Ds(on)}	Drain-Source On Resistance ²	$V_{GS}=-10V, I_D=-7A$	---	180	190	$m\Omega$
		$V_{GS}=-4.5V, I_D=-6A$	---	192	220	
Dynamic Characteristics⁴						
C_{iss}	Input Capacitance	$V_{DS}=-15V, V_{GS}=0V, f=1MHz$	---	1485	---	pF
C_{oss}	Output Capacitance		---	126	---	
C_{rss}	Reverse Transfer Capacitance		---	103	---	
Switching Characteristics⁴						
t_{d(on)}	Turn-On Delay Time	$V_{DS}=-50V, I_D=-7A, R_{GEN}=6 \Omega, V_{GS}=-10V$	---	7	---	ns
t_r	Rise Time ^{2,3}		---	7	---	ns
t_{d(off)}	Turn-Off Delay Time ^{2,3}		---	62	---	ns
t_f	Fall Time ^{2,3}		---	25	---	ns
Q_g	Total Gate Charge ^{2,3}		---	24	---	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	6.8	---	nC
Q_{gd}	Gate-Drain "Miller" Charge ^{2,3}		---	11	---	nC
Drain-Source Diode Characteristics						
I_s	Maximum Continuous Drain to Source Diode Forward Current	$VD=VG=0V$	---	---	-15	A
I_{sM}	Maximum Pulsed Drain to Source Diode Forward Current	$VD=VG=0V$	---	---	-50	A
V_{SD}	Drain to Source Diode Forward Voltage	$GS = 0V, IS = -7A$	---	---	-0.86	V

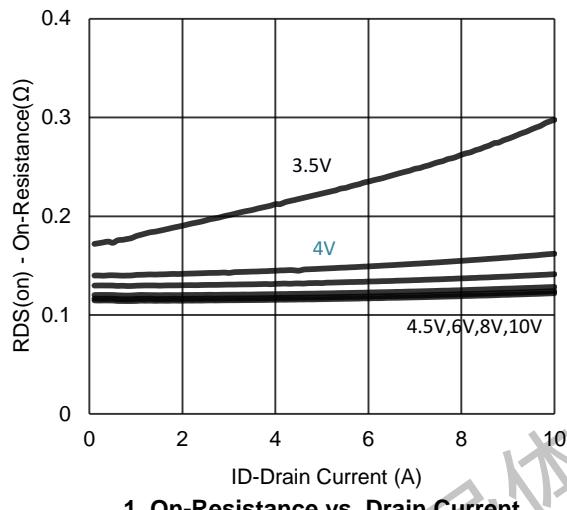
Notes:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

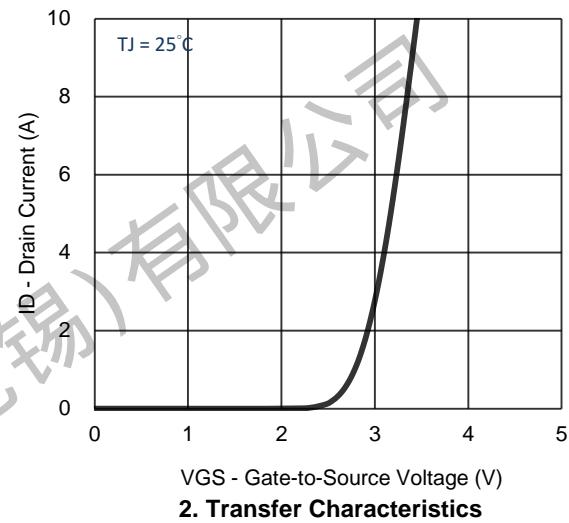
TM15G10GD

N+P-Channel Enhancement Mode Mosfet

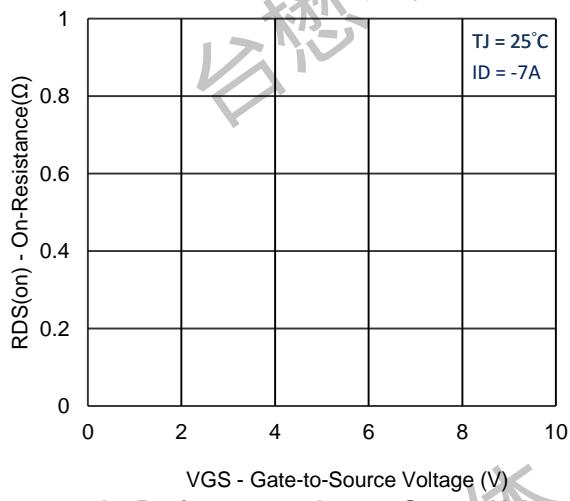
Typical Characteristics-P



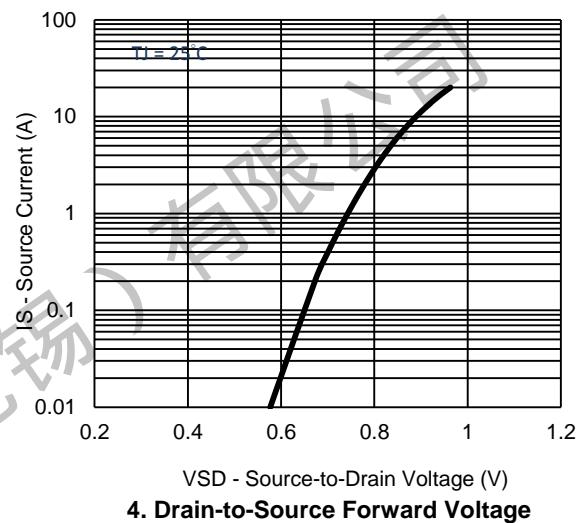
1. On-Resistance vs. Drain Current



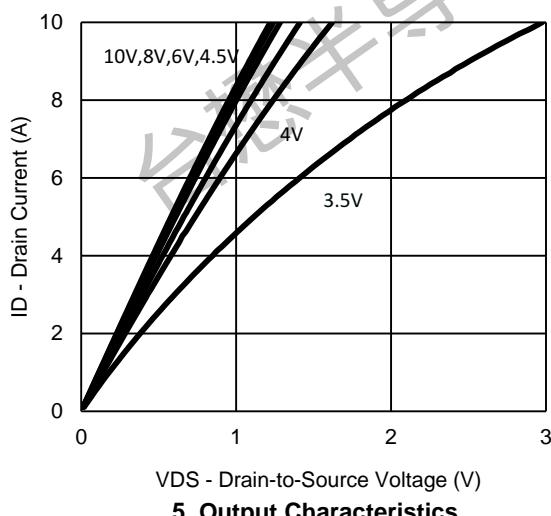
2. Transfer Characteristics



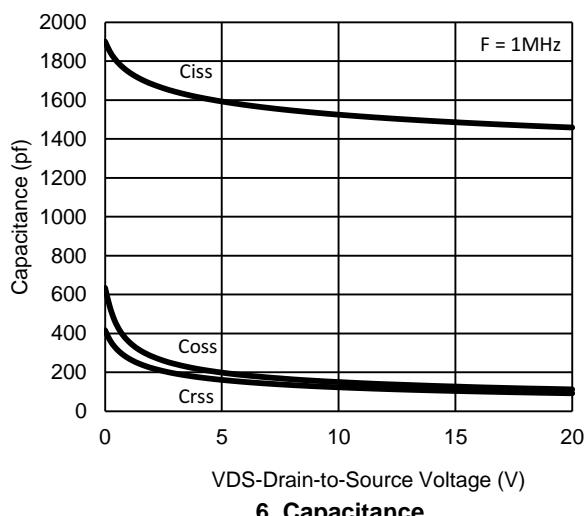
3. On-Resistance vs. Gate-to-Source Voltage



4. Drain-to-Source Forward Voltage



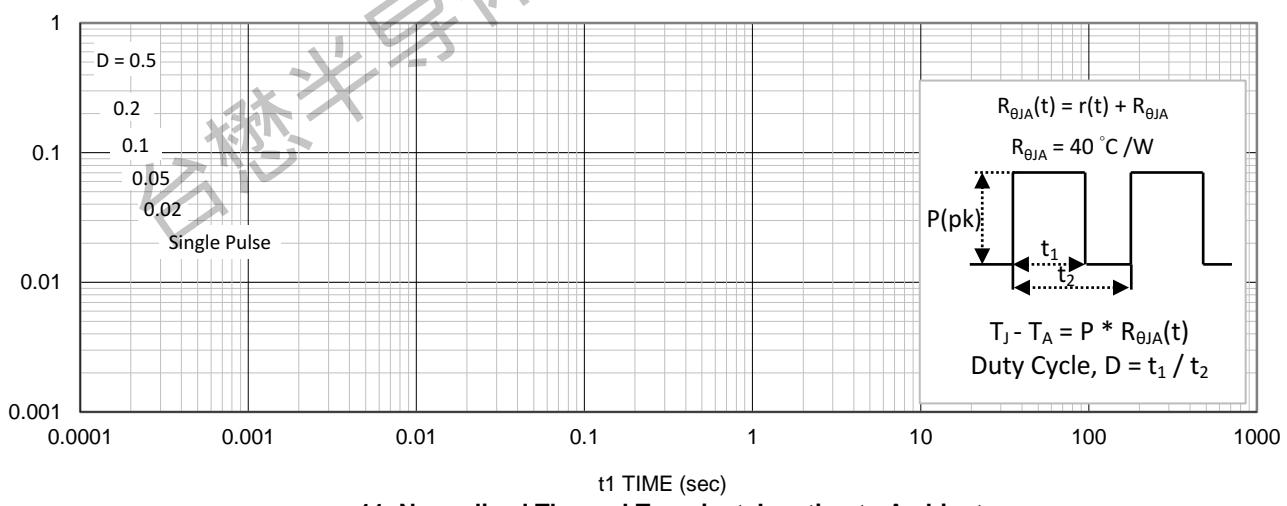
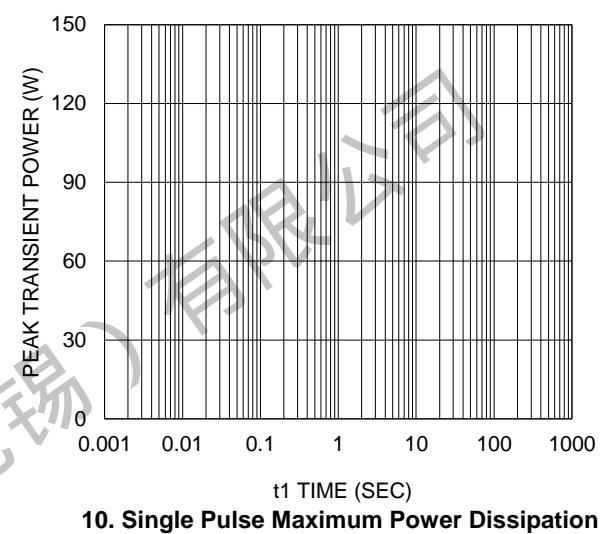
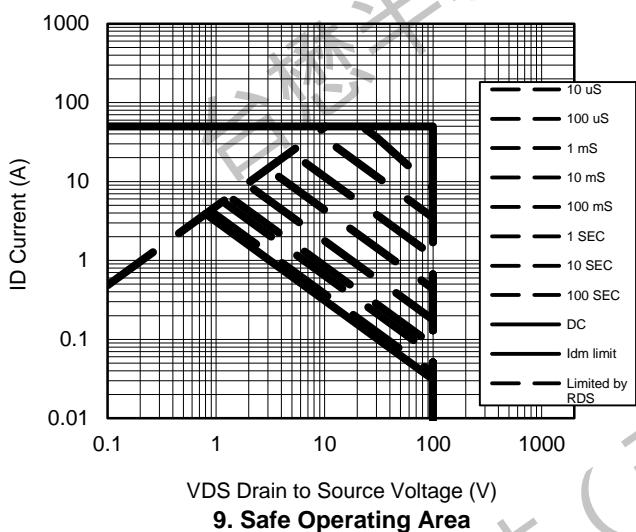
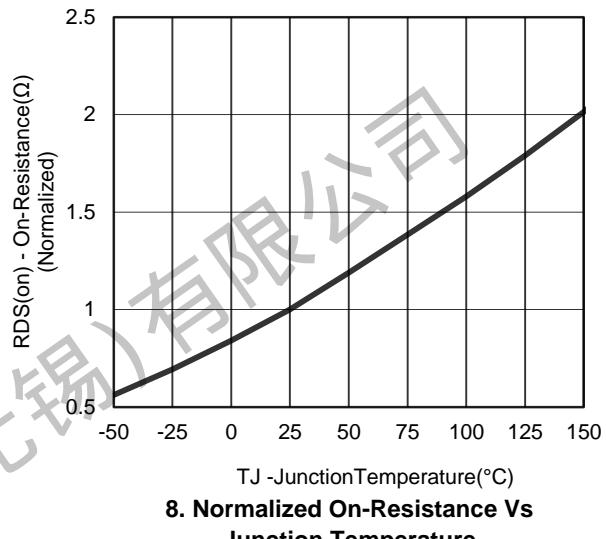
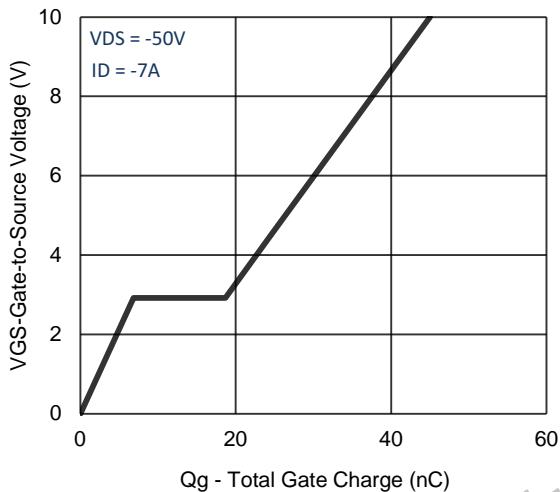
5. Output Characteristics



6. Capacitance

TM15G10GD

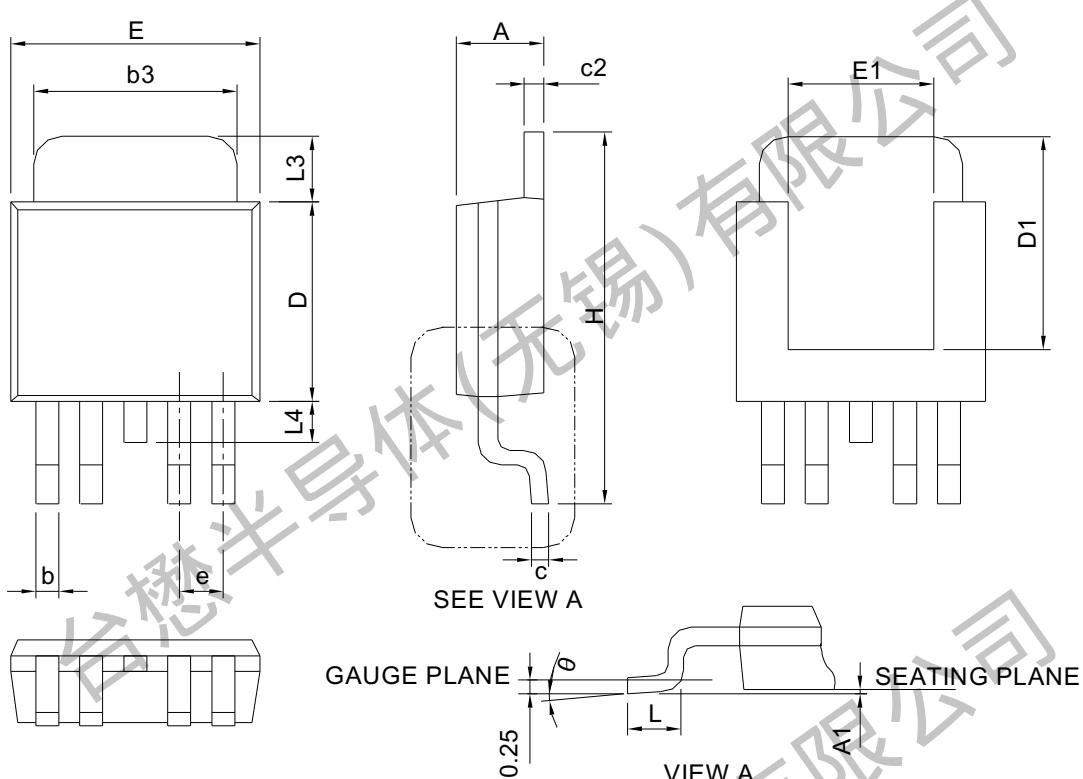
N+P-Channel Enhancement Mode Mosfet



TM15G10GD

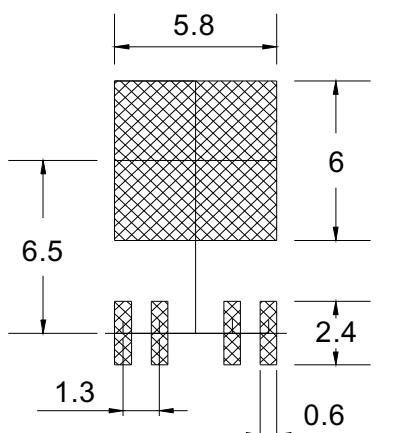
N+P-Channel Enhancement Mode Mosfet

Package Mechanical Data: TO-252-4L



S Y M O R E	TO-252-4			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1	-	0.2	-	0.008
b	0.50	0.71	0.020	0.028
b3	4.32	5.46	0.170	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	1.30 BSC		0.051 BSC	
H	9.40	10.41	0.370	0.410
L	1.40	1.78	0.055	0.070
L3	0.89	2.03	0.035	0.080
L4	-	1.02	-	0.040
θ	0°	8°	0°	8°

RECOMMENDED LAND PATTERN

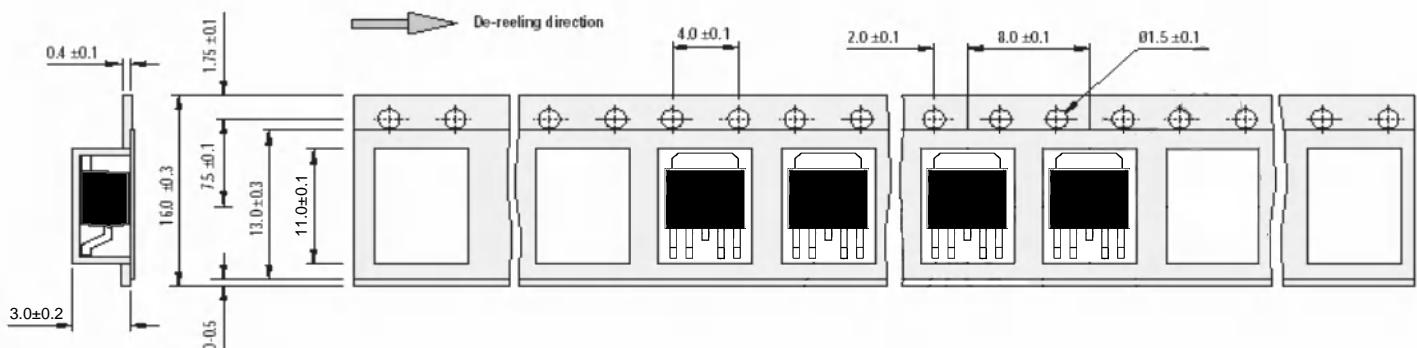


UNIT: mm

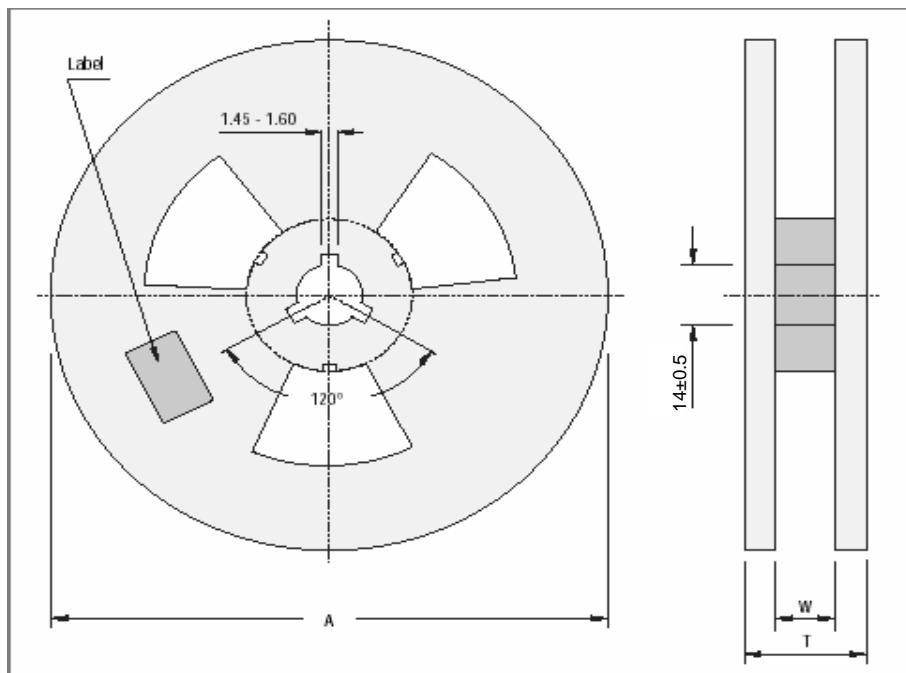
TM15G10GD

N+P-Channel Enhancement Mode Mosfet

TO-252-4L Embossed Carrier Tape



TO-252-4L Reel



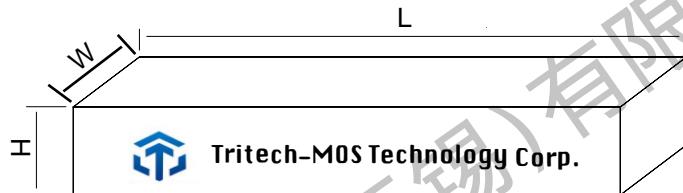
1.TO-252-4L Packaging

Package	Packing Form	Quantity		
		Reel	Inner Box	Outbox
TO-252-4L	Reel	2500	5	1

TM15G10GD

N+P-Channel Enhancement Mode Mosfet

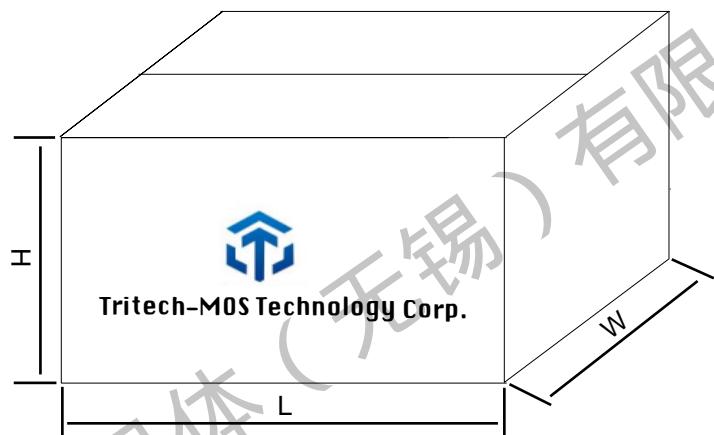
Inner Box



Dimension : 370 (L)×355(W) ×50(H) mm

Quantity : 2500 × 2Ea = 5000pcs

Outer Box



Dimension : 380(L)×380(W) ×275(H) mm

Quantity : 5000 × 5Ea = 25000pcs

Important Notices and Disclaimers

- Tritech-MOS Technology Corp. reserves the right to change this document, its products, and specifications at any time without prior notice.
- Before final design, purchase, or use, customers should obtain and confirm the latest product information and specifications.
- Tritech-MOS Technology Corp. makes no warranties, representations or warranties regarding the suitability of its products for any specific purpose, and Tritech-MOS Technology Corp. does not assume any responsibility for application assistance or customer product design.
- Tritech-MOS Technology Corp. does not guarantee or assume any responsibility for the purchase or use of any unexpected or unauthorized products.
- Any intellectual property rights of Tritech-MOS Technology Corp. are not licensed through implication or other means.
- Products of Tritech-MOS Technology Corp. are not included as critical components in life support equipment or systems without explicit written approval from Tritech-MOS Technology Corp.

Revision history:

Date	Rev	Description	Page
2023.08.10	23.08	Original	